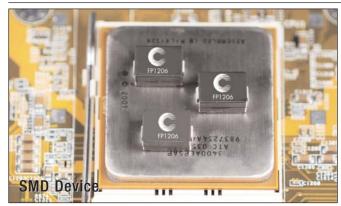


High Current, High Frequency, Power Inductors

FLAT-PAC™ FP1206 Series



Description

- Halogen free
- 125°C maximum total temperature operation
- 8.0 x12.0 x 6.0mm surface mount package
- Ferrite core material
- High current carrying capacity, low core losses
- Designed for high speed, high current switch mode applications
- Controlled DCR tolerance for sensing circuits
- Inductance range from 120nH to 400nH
- Current range from 24 to 88 amps
- Frequency range up to 1MHz
- · RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Desktop and server VRMs and EVRDs
- · Data networking and storage systems
- · Notebook regulators
- Graphics cards and battery power systems
- Point of load modules
- DCR current sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (with derated current)
- Solder reflow temperature: J-STD-020D compliant

Packaging

• Supplied in tape-and-reel packaging, 620 parts per reel, 13" diameter reel

| | | | Product Spec | ifications | | | |
|---------------------|------------|------------------|--------------------|---------------------|---------------------|-------------------|-----------|
| Part | OCL1 | FLL ² | I _{rms} ³ | I _{sat} 1⁴ | I _{sat} 2⁵ | DCR (m Ω) | |
| Number ⁷ | ± 10% (nH) | Min. (nH) | (Amps) | (Amps) @25°C | (Amps) @125°C | @20°C | K-factor6 |
| FP1206R1-R12-R | 120 | 86 | | 88 | 65 | | 358 |
| FP1206R1-R15-R | 150 | 108 | | 70 | 51 | | 358 |
| FP1206R1-R25-R | 250 | 180 | 50 | 43 | 32 | $0.43 \pm 6.5\%$ | 358 |
| FP1206R1-R30-R | 300 | 216 | | 34 | 26 | | 358 |
| FP1206R1-R40-R | 400 | 288 | | 24 | 19 | | 358 |

- Open Circuit Inductance (OCL) Test Parameters: 100kHz, $0.1V_{\mbox{rms}}$, $0.0\mbox{Adc}$
- Full Load Inductance (FLL) Test Parameters: 100kHz, .011/_{rms}, !sat1
 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the
- 4 Isat1: Peak current for approximately 20% rolloff at +25°C.

- 5 I_{sat} 2: Peak current for approximately 20% rolloff at +125°C. 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I * 10 °. B_{p-p}$:(Gauss), K: (K-factor from table), L: (Inductance in nH), Δ I (Peak-to-peak ripple current in amps).

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- 7 Part Number Definition: FP1206Rx-Rxx-R
 - FP1206 = Product code and size
 - Rx= DCR indicator
 - Rxx= Inductance value in uH, R = decimal point
 - -R suffix = RoHS compliant



HALOGEN

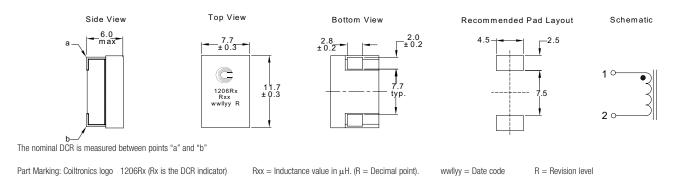




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Dimensions - mm



Packaging Information - mm

1.5 dia

2.0

4.0

1.75

1.75

24.0

1.8 dia

1.75

24.0

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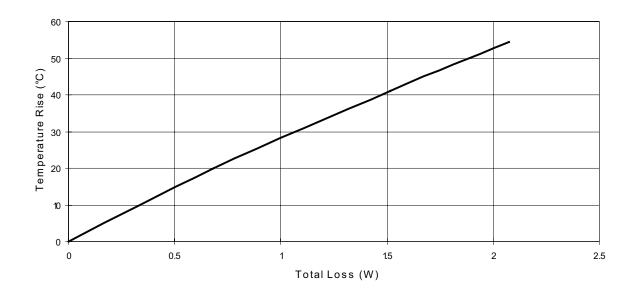
1.75

1

Supplied in tape-and-reel packaging, 620 parts per reel, 13" diameter reel.

Temperature Rise vs.Total Loss

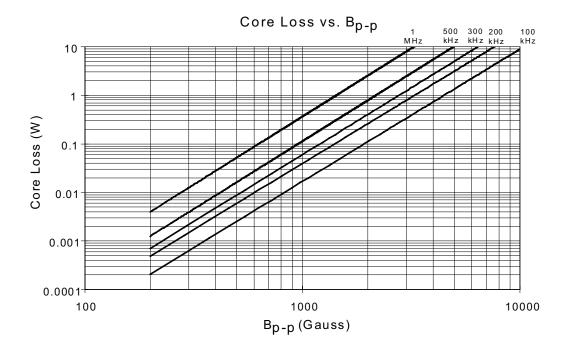
Section A-A



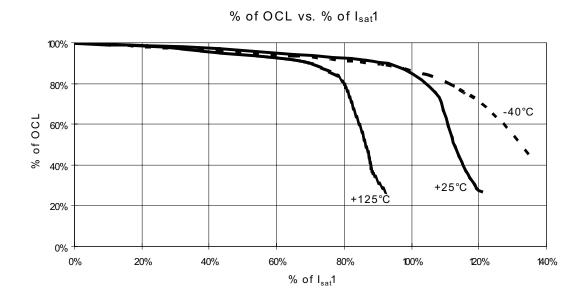
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Core Loss



Inductance Characteristics



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Solder Reflow Profile

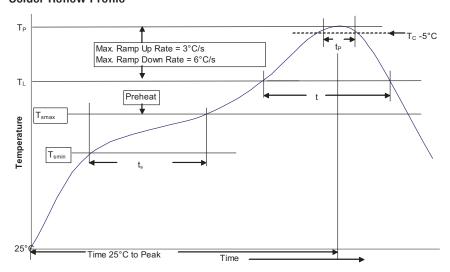


Table 1 - Standard SnPb Solder (T_C)

| Package | Volume mm³ | Volume mm³ |
|-----------|---------------|---------------|
| Thickness | <350 | ≥350 |
| <2.5mm | 235°C | 220°C |
| ≥2.5mm | 220°C | 220°C |

Table 2 - Lead (Pb) Free Solder (Tc)

| Package | Volume mm³ | Volume mm³ | Volume mm³ |
|-------------|---------------|---------------|---------------|
| Thickness | <350 | 350 - 2000 | >2000 |
| <1.6mm | 260°C | 260°C | 260°C |
| 1.6 - 2.5mm | 260°C | 250°C | 245°C |
| >2.5mm | 250°C | 245°C | 245°C |

Reference JDEC J-STD-020D

| Profile Feature | | Standard SnPb Solder | Lead (Pb) Free Solder | |
|-------------------------------------|--|----------------------|-----------------------|--|
| Preheat and Soak | Temperature min. (T_{smin}) | 100°C | 150°C | |
| | Temperature max. (T _{smax}) | 150°C | 200°C | |
| | • Time (T _{smin} to T _{smax}) (t _s) | 60-120 Seconds | 60-120 Seconds | |
| Average ramp up rat | te T _{smax} to T _p | 3°C/ Second Max. | 3°C/ Second Max. | |
| Liquidous temperature (TL) | | 183°C | 217°C | |
| Time at liquidous (t _L) | | 60-150 Seconds | 60-150 Seconds | |
| Peak package body | temperature (T _P)* | Table 1 | Table 2 | |
| Time (t _p)** within 5 | °C of the specified classification temperature (T _C) | 20 Seconds** | 30 Seconds** | |
| Average ramp-down | rate (T _p to T _{smax}) | 6°C/ Second Max. | 6°C/ Second Max. | |
| Time 25°C to Peak Temperature | | 6 Minutes Max. | 8 Minutes Max. | |

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.